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U.S. Patent and Tra	PTO/SB/21 (04-04) pproved for use through 07/31/2006. OMB 0651-0031 demark Office: U.S. DEPARTMENT OF COMMERCE information unless it displays a valid OMB control number.
Application Number	10/779,563
Filing Date	February 16, 2004
First Named Inventor	Yoshiro Iwasa
Art Unit	2826
Examiner Name	Alexander O. Williams
Attorney Docket Number	9319S-000666

ENCLOSURES (check all that apply)									
Fee Transmittal F	Form	☐ Drawing(s)		After Allowance Communication to Technology Center (TC)					
Fee Attached	I	Licensing-r	elated Papers	Appeal Communication to Board of Appeals and Interferences					
Amendment / Reply		Petition		Appeal Communication to TC (Appeal Notice, Brief, Reply Brief)					
After Final		Petition to Convert to a Provisional Application		Proprietary Information					
Affidavits/declaration(s)		Power of Attorney, Revocation Change of Correspondence Address		Status Letter					
Extension of Time Request		Terminal Disclaimer		Other Enclosure(s) (please identify below):					
Express Abandonment Request		Request for Refund		Return Receipt Postcard					
		CD, Number of CD(s)							
Information Disclosure Statement			·						
Certified Copy of Priority Document(s)		Remarks The Commissioner is hereby authorized to charge any additional fees that may be required under 37 CFR 1.16 or 1.17 to Deposit Account No. 50-3213. A duplicate copy of this sheet is enclosed.							
Response to Missing Parts/ Incomplete Application									
Response to Missing Parts under 37 CFR									
1.52 01 1.53	1.52 or 1.53								
	SIGNA	TURE OF APP	LICANT, ATTORNEY, O						
Firm or Individual name	Harness, Dickey & Pierce, P.L.C.		Attorney Name G. Gregory Schivley Bryan E. Wade	Reg. No. 27,382 / 40,344					
Signature	J. Kegan plinter								
Date	December 19, 2005								
CERTIFICATE OF TRANSMISSION/MAILING									

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Signature	11. huxen llu	olun	Date	December 19, 2005

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## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application No.:

10/779,563

Filing Date:

February 16, 2004

Applicant:

Yoshiro Iwasa

Group Art Unit:

2826

Examiner:

Alexander O. Williams

Title:

LEAD FRAME FOR ACCOMMODATING SEMICONDUCTOR

CHIPS OF VARIOUS DIFFERENT SIZES

Attorney Docket:

9319S-000666

Mail Stop Amendment Commissioner for Patents P.O. Box 1450 Alexandria, Virginia 22313-1450

## <u>AMENDMENT</u>

Sir:

In response to the Office Action mailed September 22, 2005, please amend the application as follows and consider the remarks set forth below.

Amendments to the Title begin on page 2 of this paper.

Amendments to the Claims begin on page 3 of this paper.

Remarks begin on page 5 of this paper.

## **AMENDMENTS TO THE TITLE**

Please amend the title as rewritten in amendment format.

LEAD FRAME, SEMICONDUCTOR CHIP PACKAGE, METHOD FOR MANUFACTURING SEMICONDUCTOR DEVICE, AND SEMICONDUCTOR DEVICE

<u>LEAD FRAME FOR ACCOMMODATING SEMICONDUCTOR CHIPS OF VARIOUS DIFFERENT SIZES</u>